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PRODUCT CHANGE NOTIFICATION

PCN: PCN08132024

Date: Aug 13, 2024

Subject: Changes information on the labels

To: PCN ADMIN

Change Type: Minor

1. Description of Change

SkyHigh plans to update the information on the product labels, with the changes scheduled to be implemented on November 1, 2024. After this date, customers may receive both the current and new labels for a period of time, depending on the inventory status of products with the current labels. The key changes are listed in the table below, and the update will affect all products sold by SkyHigh.

1-1. Change scope

The changed items along with the label categories are described on table below.

Label Category	Label information		Change details	Example	
	Items	Description		As-Is	To-Be
2 in 1 Label attached on Aluminum Bag	(1P) MFR#	Manufacturing Part Number	Remove this information	S34ML01G200TFI003Z	None
	Seal DC	Date code for package sealing	Format changes from alphanumeric 7 characters to 4 characters for Year and Workweek	2404DNE	2404
	(7Q) QTY	Quantity of the child lot	Remove this information	02300PC	None
Q-Pack Label attached on Box	(1P) MFR#	Manufacturing Part Number	Remove this information	S34ML01G200TFI003Z	None
	Seal DC	Date code for package sealing	Format changes from alphanumeric 7 characters to 4 characters for Year and Workweek	2404DNE	2404
	(7Q) QTY	Quantity of the child lot	Remove this information	02300PC	None
	(3N)	Serial No	Remove this information	2 2376564199 107210	None
	Concode	Information for internal use only	Remove this information	41800XX-SUB-TC	None
Standard Reel label	(1Z) Box ID	Box ID	Optimized the number of characters	1ZK690949000012300	1ZK69094900012300
	(1P) MFR#	Manufacturing Part Number	Remove this information	S34ML01G200TFI003Z	None
	(7Q) QTY	Quantity of the child lot	Remove this information	02300PC	None
	Reel ID barcode	Reel ID barcode	Added to the label	None	2ZK690949000012300

[Note] Please refer to the example of change references on the appendix1.

1-2. Affected Product:

All products sold by SkyHigh.

1-3. Approximate Implementation:

SkyHigh will implement this change starting on November 1st, 2024. Please note that customers may receive materials with both the current label and the new label for a period of time, depending on the inventory status of the products.

1-4. Response Required:

This is an informational announcement only. No response is required

For additional information regarding this change, contact your local sales representative or contact the PCN Administrator at quality@skyhighmemory.com.

Sincerely,
SkyHigh Memory PCN Administration

[Appendix 1] Change examples

[2 in 1 Label attached on Aluminum Bag]

The current label

(P) OPN: S34MS08G201BHB003

(1P) MFR# S34MS08G201BHB003

(1T) BATCH# 000

SEAL DC: 2337MBM

Mark Date Code

(9D) M/C: 33988632 (7Q) QTY: 00230PC

(9D) M/C: 33988687 (7Q) QTY: 00087PC

(9D) M/C: 34088332 (7Q) QTY: 00312PC

(9D) M/C: 34088688 (7Q) QTY: 01671PC

(Q) TTL QTY: 2300

LOT# K690949 BAG ID: 0001 QTY: 2300

(Z) BAG ID:

CAUTION JEDEC LEVEL 3 JEITA RANK -

RoHS 2Li This Bag Contains MOISTURE SENSITIVE DEVICES Category = e1

1. Calculated shelf life in sealed bag: Minimum 12 months at < 40 °C and < 60 % relative humidity (RH).

2. Peak package body temperature: 260 °C.

3. After bag is opened, devices that will be subjected to solder reflow or other high temperature process must:

a) Mounted within 168 HOURS of factory conditions < 30 °C/70 % RH, OR

b) Stored per J-STD-033

4. Devices require bake, before mounting, if:

a) Humidity Indicator Card is > 10 % for level 2a - 5a devices or > 60 % for level 2 devices when read at 25 °C ± 5 °C

b) 3a or 3b not met

5. If baking is required, devices may be baked for 24 hours at 125 °C ± 5 °C. Refer J-STD-033 for shorter time durations, if applicable.

Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake reference

Bag Seal Date: 190CT23

(If blank, see adjacent bar code label)

Note: Level and body temperature defined by IPC/JEDEC J-STD-020 for JEDEC and EIAJ-ED 4701/300 for JEITA

The new label

(P) OPN: S34MS08G201BHB003

(1T) BATCH# 000

SEAL DC: 2337

Mark Date Code

(9D) M/C: 33988632 (7Q) QTY: 02300PC

(9D) M/C: 33988687

(9D) M/C: 34088332

(9D) M/C: 34088688

(Q) TTL QTY: 2300

LOT# K690949 BAG ID: 0001 QTY: 2300

(Z) BAG ID:

CAUTION JEDEC LEVEL 3 JEITA RANK -

RoHS 2Li This Bag Contains MOISTURE SENSITIVE DEVICES Category = e1

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Bag Seal Date: 190CT23

(If blank, see adjacent bar code label)

Note: Level and body temperature defined by IPC/JEDEC J-STD-020 for JEDEC and EIAJ-ED 4701/300 for JEITA

Change description

1. Remove (1P) MFR# from label
Ex: S34ML01G200TFI003Z
2. Change seal DC from YYWWABC to YYWW
Ex: 1736DNE to 1736
3. Remove (7Q) QTY of child lot combine

[Q-Pack Label attached on Box]

The current label

(1D) DRYPACK SEALED DATE: 190CT23

SPEC# PF-46958 06M

IDV T463ADUM PK3 VLD063 FULL CNTR QTY 2300

(1P) MFR# S34MS08G201BHB003Z

(P) OPN S34MS08G201BHB003

(1Z) BOX ID K690949

HU 001 BOX 001 OF

HULN K6909490000001

(1T) BATCH# K690949 000

(3N) 2 2338219587 107210 2337 MBM 02300

SEAL DC 2337MBM TTL QTY (Q) 02300

ASSEMBLED IN: GH A41086KV-4R8-UM2 THAILAND

Mark Date Code

(9D) M/C: 33988632 (7Q) QTY: 00230PC

(9D) M/C: 33988687 (7Q) QTY: 00087PC

(9D) M/C: 34088332 (7Q) QTY: 00312PC

(9D) M/C: 34088688 (7Q) QTY: 01671PC

The new label

(1D) DRYPACK SEALED DATE: 190CT23

SPEC# PF-46958 06M

IDV T463ADUM PK3 VLD063 FULL CNTR QTY 2300

(P) OPN S34MS08G201BHB003

(1Z) BOX ID K690949

HU 001 BOX 001 OF

HULN K6909490000001

(1T) BATCH# K690949 000

SEAL DC 2337 TTL QTY (Q) 02300

ASSEMBLED IN: GH THAILAND

Mark Date Code

(9D) M/C: 33988632 (7Q) QTY: 02300PC

(9D) M/C: 33988687

(9D) M/C: 34088332

(9D) M/C: 34088688

Change description

1. Remove (1P) MFR# from label
Ex: S34ML01G200TFI003Z
2. Remove (3N) Serial No
EX: 2 2376564199 107210
3. Change seal DC from YYWWABC to YYWW
Ex: 1736DNE to 1736
4. Remove concode from label
Ex: 41800XX-SUB-TC
5. Remove (7Q) QTY of child lot combine
6. Change Box ID Barcode INFO from "1ZK690949000012300" to "1ZK69094900012300" (remove 1 Char of box number)

[Standard Reel Label]
The current label

(P) OPN: S34MS08G201BHB003
 (1P) MFR# S34MS08G201BHB003Z
 (1T) BATCH# K690949 000
 Mark Date Code
 (Q) TTL QTY: 2300
 LOT# K690949

1

2

2

The new label

(P) OPN: S34MS08G201BHB003
 (1T) BATCH# K690949 000
 Mark Date Code
 (Q) TTL QTY: 2300
 LOT# K690949
 (ZZ) REEL ID

1

2

3

Change description

1. Remove (1P) MFR# from label
Ex: S34ML01G200TFI003Z
2. Remove (7Q) QTY of child lot combine
3. Add Reel ID Barcode
"2ZK690949000012300"

Affected Part Number	Affected Part Number	Affected Part Number	Affected Part Number
S34ML01G100TFI000	S34ML08G101BHI000	S34ML08G201TFI000	S34MS04G100BHI000
S34ML02G100TFI000	S34ML08G101TFI200	S34MS04G200BHI000	S34ML02G200BHI000
S34ML04G100TFI000	S34MS01G104BHI010	S34ML01G200BHI000	S34MS02G100BHI000
S34ML01G100BHI000	S34MS02G104BHI010	S34ML02G100BHI000	S34MS04G100TFI000
S34ML04G100BHI000	S34ML02G104TFI010	S34MS01G100BHI000	S34MS08G201BHI000